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Date: November 2, 2006

Customer No.

026418

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Attorney's Docket No.:

JG-SU-5224/500577.20073

U.S. Application No.:

10/562.235

International Application No.:

PCT/JP2005/006268

International Filing Date:

Priority Date Claimed:

MARCH 31, 2005

APRIL 05, 2004

31 MARCH 2005 04 APRIL 2004

Filing Date: December 22, 2005

Title of Invention:

MANUFACTURING METHOD OF SEMICONDUCTOR WAFFR AND

Applicant(s) for (DO/EO/US):

SEMICONDUCTOR WAFER MANUFACTURED BY THIS METHOD Svouii NOGAMI, Yukichi HORIOKA, and Shoichi YAMAUCHI

MAIL STOP MISSING PARTS Commissioner for Patents PO Box 1450 Alexandria, VA 22313-1450

## SUPPLEMENTAL RESPONSE TO NOTIFICATION OF MISSING REQUIREMENTS UNDER 35 U.S.C 371 IN THE UNITED STATES DESIGNATED/ELECTED OFFICE (DO/EO/US)

Sir

Applicants submit herewith the following in order to complete the above application:

Executed Declaration and Power of Attorney.

Applicant is entitled to claim Small Entity Status [See 37 CFR 1.27].

Preliminary Amendment

Priority Document(s) No(s). ()

, the priority(ies) of which is(are) claimed under 35 USC 119.

(X) A copy of the Formalities Letter Confirmation No. 8539 dated September 20.

Authorization to charge Deposit Account No. 50-1529 in the amount of

() \$130.00

With the filing of these documents, it is submitted that the application is now complete and in form for examination. Accordingly, such examination and favorable action are earnestly solicited

Dated: November 2, 2006

Respectfully submitted.

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